ADVANCED SEMICONDUCTOR ENGINEERING INC Form 6-K May 25, 2007

#### FORM 6-K SECURITIES AND EXCHANGE COMMISSION Washington, D.C. 20549

## **Report of Foreign Private Issuer**

## Pursuant to Rule 13a-16 or 15d-16 of the Securities Exchange Act of 1934

May 25, 2007

Commission File 001-16125 Number

Advanced Semiconductor Engineering, Inc.

(Exact name of Registrant as specified in its charter)

26 Chin Third Road Nantze Export Processing Zone Kaoshiung, Taiwan Republic of China (Address of principal executive offices)

Indicate by check mark whether the registrant files or will file annual reports under cover of Form 20-F or Form 40-F.

Form 20-F X\_ Form 40-F \_\_\_\_

Indicate by check mark if the registrant is submitting the Form 6-K in paper as permitted by Regulation S-T Rule 101(b)(1):

**Note:** Regulation S-T Rule 101(b)(1) only permits the submission in paper of a Form 6-K if submitted solely to provide an attached annual report to security holders.

Indicate by check mark if the registrant is submitting the Form 6-K in paper as permitted by Regulation S-T Rule 101(b)(7):

**Note:** Regulation S-T Rule 101(b)(7) only permits the submission in paper of a Form 6-K if submitted to furnish a report or other document that the registrant foreign private issuer must furnish and make public under the laws of the jurisdiction in which the registrant is incorporated, domiciled or legally organized (the registrant's "home country"), or under the rules of the home country exchange on which the registrant's securities are traded, as long as the report or other document is not a press release, is not required to be and has not been distributed to the registrant's security holders, and, if discussing a material event, has already been the subject of a Form 6-K submission or other Commission filing on EDGAR.

Indicate by check mark whether by furnishing the information contained in this Form, the registrant is also thereby furnishing the information to the Commission pursuant to Rule 12g3-2(b) under the Securities Exchange Act of 1934.

Yes \_\_\_\_\_ No <u>X</u>\_\_\_\_

If "Yes" is marked, indicate below the file number assigned to the registrant in connection with Rule 12g3-2(b): Not applicable

# Signatures

Pursuant to the requirements of the Securities Exchange Act of 1934, the registrant has duly caused this report to be signed on its behalf by the undersigned, thereunto duly authorized.

# ADVANCED SEMICONDUCTOR ENGINEERING, INC.

Date: May 25, 2007

By: <u>/s/ Joseph Tung</u> Name: Joseph Tung Title: Chief Financial Officer Meeting Agenda

# Edgar Filing: ADVANCED SEMICONDUCTOR ENGINEERING INC - Form 6-K

# **Contents**

Meeting Procedure					1
Meeting Agenda					2
Status Report					3
Matters of Ratification					5
Matters of Discussions					7
Other Proposals and Extem motions	ı p	0	r	e	12

Attachments:			
	Ι	2006 Business Report	13
	II	Supervisors' Report	17
	III	Report on the Company's legislation of Rule of Procedure for the Board of Directors Meeting	18
	IV	Financial Statements for the Years Ended December 31, 2006 and 2005 and Independent Auditors' Report	23
	V	Table of Comparison of Revised Procedure for Acquisition or Disposal of Assets	45
	VI	Table of Comparison of Revised Articles of Incorporation	53
Appendixes:			
	Ι	Rules of Procedure for Shareholders' Meeting	54
	II	Articles of Incorporation (before revision)	57
	III	Status of Holdings by Directors and Supervisors	62
	IV	Status of Distribution of Bonus to employees and Remuneration for Directors and Supervisors under the Profit Distribution Proposal Approved by the Board of Directors	63
	V	Impact of Non-Remunerative Stock Dividend Distribution on the Company's Operating Performance and Earnings Per Share	64

Advanced Semiconductor Engineering, Inc.

2007 Annual Shareholders' Meeting

# MEETING PROCEDURE

- **1.** Meeting called to order (announcing respective holding of shareholders present)
- 2. Chairperson's opening remarks
- 3. Status report
- 4. Matters for ratification
- 5. Matters for discussions
- 6. Other Proposals and extempore motions
- 7. Meeting ended.

# Advanced Semiconductor Engineering, Inc.

## 2007 Annual Shareholders' Meeting Agenda

- 1. Time: Thursday, June 28, 2007 at 10 a.m.
- 2. Place: Zhuang Jing Auditorium, 600 Jiachang Rd., Nantz Processing Export Zone, Nantz District, Kaohsiung City
- 3. Present : All shareholders and proxies
- 4. Chairperson's Remarks
- 5. Status Report
  - 1. 2006 Business Report
  - 2. Supervisor's Report on 2006 final financial statements
  - 3. Report on total amount for endorsement, guarantee and amount of loans to third parties.
  - 4. Report on the Company's indirect investment on Mainland China and the implementation thereof.
  - 5. Report on the Rules of Procedure for the Board of Directors Meeting.

## 6. Matters for Ratification

Item Ratification of the Company's 2006 final financial statements

1:

Item Ratification of the Company's 2006 earnings distribution proposal

2:

## 7. Matters for Discussions

Case Discussions of issuance of new shares for capital increase by retained earning and employee bonus

 Discussions of authorizing the Board to opt at the optimal time for capital increase in cash by joining the issuance of GDR (Global depository receipts) or domestic capital increase in cash or issuance of domestic or ECB to raise fund.

 Case Discussions of revision of Procedure for Acquisition or Disposal of Assets.

 III: Case Discussions of revision of Articles of Incorporation

 IV:

# 8. Other Proposals and Extempore Motions

#### 9. Meeting ended

- 2 -

# **Status Report**

- 1. The Company's 2006 Business Report (proposed by the Board of Directors) Explanation: Please see Attachment I for the 2006 Business Report attached to this Agenda Manual.
- 2. Supervisors' Report on 2006 Actual Budget (proposed by the Board of Directors) Explanation: Please see Attachment II for the Supervisors' Report attached to this Agenda Manual.
- 3. Report of the Company's aggregate amount of endorsements and guarantees and amounts of loans extended to others as of December 31, 2006 (proposed by the Board of Directors)

Explanation: 1. Details of the Company's amounts of endorsements and guarantees as of December 31, 2006 are as follows:

#### Unit: NT\$1,000

Warrantee	Relationship	Amount Guaranteed
ASE Test Finance Ltd.	A great grand-son company that an ASE subsidiary has indirect holdings in excess of 50%	2,542,488 (Note1)
ASE Singapore Pte Ltd.	A great grand-son company that an ASE subsidiary has indirect holdings in excess of 50%	701,977
ASE Electronic Inc.	A great grand-son company that an ASE subsidiary has indirect holdings in excess of 50%	1,955,760
ASE (Shanghai) Inc.	A great grand-son company that an ASE subsidiary has indirect holdings in	4,856,804

	excess of 30%	
For joint use by ASE (Shanghai) Ltd., ASE Module (Shanghai) Inc. and ASE (Kunshan) Inc.	A great grand-son company that an ASE subsidiary has indirect holdings in excess of 50%	488,940
For joint use by ASE (Shanghai) Ltd., ASE Module (Shanghai) Inc. and ASE (Kunshan) Inc. and ASE Hi-Tech (Shanghai) Co., Ltd.	A great grand-son company that an ASE subsidiary has indirect holdings in excess of 50%	1,792,780
Omniquest Industrial Limited	•	71,711
Grand Total		12,410,460

excess of 50%

# Edgar Filing: ADVANCED SEMICONDUCTOR ENGINEERING INC - Form 6-K

Note 1: This is the Company's joint guarantee for a syndicate loan of US\$78,000,000 for subsidiaries ASE Test Finance Ltd. and ASE Test Ltd.

2. At the time of writing, the company does not have loans granted to others.

## D. Report on the Company's indirect investment on Mainland China (proposed by the Board of Directors)

#### Explanation:

1. The following depicts the newly added indirect investment out of the Company's own reserves on Mainland China via third countries in 2006:

Approval No. by Investment Commission, MOEA	Name of company on Mainland China being invested	Amount approved
Ching-Shen-Er-Tze-#09500185060 dated 08.01/2006	ASE (Kunshan) Inc.	US\$30 million

2. The following depicts the newly added indirect investment out of the coffer of the Company's overseas subsidiary on Mainland China via third countries in 2006:

Approval No. by Investment Commission, MOEA	Name of company on Mainland China being invested	Amount approved
Ching-Shen-Er-Tze-#09500324630 dated 12.19/2006	Global Advanced Packaging Technology Limited	US\$60 million

# **E.** Report on the Company's legislation of the Rules of Procedure for the Board of Directors Meeting (proposed by the Board of Directors)

#### Explanation:

1. In order to meet the requirements set forth by Article 26-3 of The Securities Trading Act and other related laws and regulations, the Company's board of directors adopted the resolution on December 21, 2006 to revise the Rules of Precedure for the Board of Directors Meeting.

2. For details for the said Official Business Rules on Discussions by the Board of Directors, please refer to Attachment III to this Agenda Manual.

- 4 -

# **Matters for Ratification**

Item 1 (proposed by the Board of Directors)

Proposal: Explanation:	<ul> <li>Please ratify the Company's report on 2006 final financial statements.</li> <li>1. The Company's 2006 financial statements have been audited and attested by Deloitte &amp; Touche and reviewed by the Supervisors.</li> <li>2. Please ratify the financial statements (see Attachment IV for details) and the 2006 Business Report (see Attachment I for details).</li> </ul>
Resolution:	
	Item 2 (proposed by the Board of Directors)
Proposal: Explanation:	Please ratify the Company's 2006 proposal for earnings distribution. The Board of Directors has drafted the Company's 2006 proposal for surplus distribution as shown in the table below in accordance with The Company Act and the Company's Articles of Incorporation for your ratification.
	Advanced Semiconductor Engineering, Inc.

2006 Surplus Distribution Proposal